

October 1996 Revised May 2003

NC7SZ02

TinyLogic® UHS 2-Input NOR Gate

General Description

The NC7SZ02 is a single 2-Input NOR Gate from Fairchild's Ultra High Speed Series of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65V to 5.5V $V_{\rm CC}$ range. The inputs and output are high impedance when $V_{\rm CC}$ is 0V. Inputs tolerate voltages up to 6V independent of $V_{\rm CC}$ operating voltage.

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- Ultra High Speed: t_{PD} 2.4 ns typ into 50 pF at 5V V_{CC}
- High Output Drive: ±24 mA at 3V V_{CC}
- Broad V_{CC} Operating Range: 1.65V–5.5V
- \blacksquare Matches the performance of LCX when operated at 3.3V V_{CC}
- Power down high impedance inputs/output
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SZ02M5X	MA05B	7Z02	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7SZ02P5X	MAA05A	Z02	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7SZ02L6X	MAC06A	JJ	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol



Pin Descriptions

Pin Names	Description		
A, B	Inputs		
Y	Output		
NC	No Connect		

Function Table

$$Y = \overline{A + B}$$

Inp	Output	
Α	В	Y
L	L	Н
L	Н	L
Н	L	L
н	Н	L

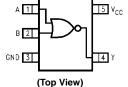
H = HIGH Logic Level

L = LOW Logic Level

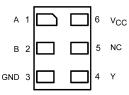
 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{\tiny TM}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Connection Diagrams

Pin Assignments for SC70 and SOT23



Pad Assignments for MircoPak



(Top Thru View)

Absolute Maximum Ratings(Note 1)

-0.5V to +6V Supply Voltage (V_{CC}) -0.5V to +6V DC Input Voltage (V_{IN}) DC Output Voltage (V_{OUT}) -0.5V to +6VDC Input Diode Current (I_{IK})

@ $V_{IN} < -0.5V$ -50 mA @ V_{IN} > 6V +20 mA

DC Output Diode Current (I_{OK})

 $0 V_{OUT} < -0.5V$ -50 mA $@V_{OUT} > 6V, V_{CC} = GND$ +20 mA DC Output Current (I_{OUT}) \pm 50 mA DC V_{CC}/GND Current (I_{CC}/I_{GND}) \pm 50 mA -65°C to +150°C Storage Temperature (T_{STG}) Junction Temperature under Bias (T_J) 150°C

Junction Lead Temperature (T_L);

(Soldering, 10 seconds) 260°C

Power Dissipation (PD) @ +85°C

SOT23-5 200 mW SC70-5 150 mW

Recommended Operating Conditions (Note 2)

Supply Voltage Operating (V_{CC}) 1.65V to 5.5V Supply Voltage Data Retention (V_{CC}) 1.5V to 5.5V Input Voltage (V_{IN}) 0V to 5.5V Output Voltage (V_{OUT}) 0V to V_{CC} -40°C to +85°C Operating Temperature (T_A)

Input Rise and Fall Time (t_r, t_f)

 V_{CC} @ 1.8V, 2.5V $\pm 0.2 V$ 0 ns/V to 20 ns/V V_{CC} @ $3.3V \pm 0.3V$ 0 ns/V to 10 ns/V V_{CC} @ $5.0V \pm 0.5V$ 0 ns to 5 ns/V

Thermal Resistance (θ_{JA})

SOT23-5 300°C/W SC70-5 425°C/W

Note 1: Absolute maximum ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside datasheet specifi-

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

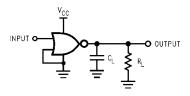
Symbol	Parameter	V _{CC}		T _A = +25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Symbol	Parameter	(V)	Min	Тур	Max	Min	Max	Units	Conditions	
V _{IH}	HIGH Level Input Voltage	1.65 to 1.95	0.75 V _{CC}			0.75 V _{CC}		V		
		2.3 to 5.5	0.7 V _{CC}			0.7 V _{CC}		V		
V _{IL}	LOW Level Input Voltage	1.65 to 1.95			0.25 V _{CC}		0.25 V _{CC}	V		
		2.3 to 5.5			$0.3~\mathrm{V}_{\mathrm{CC}}$		0.3 V _{CC}	V		
V _{OH}	HIGH Level Output Voltage	1.65	1.55	1.65		1.55				
		1.8	1.7	1.8		1.7				
		2.3	2.2	2.3		2.2		V	$V_{IN} = V_{IL} \\$	$I_{OH} = -100 \mu A$
		3.0	2.9	3.0		2.9				
		4.5	4.4	4.5		4.4				
		1.65	1.29	1.52		1.29				I _{OH} = -4 mA
		2.3	1.9	2.15		1.9				$I_{OH} = -8 \text{ mA}$
		3.0	2.4	2.80		2.4		V		I _{OH} = -16 mA
		3.0	2.3	2.68		2.3				I _{OH} = -24 mA
		4.5	3.8	4.20		3.8				I _{OH} = -32 mA
V _{OL}	LOW Level Output Voltage	1.65		0.0	0.1		0.1			
		1.8		0.0	0.1		0.1			
		2.3		0.0	0.1		0.1	V	$V_{IN} = V_{IH}$	$I_{OL} = 100 \mu A$
		3.0		0.0	0.1		0.1			
		4.5		0.0	0.1		0.1			
		1.65		0.08	0.24		0.08			I _{OL} = 4 mA
		2.3		0.10	0.3		0.3			I _{OL} = 8 mA
		3.0		0.15	0.4		0.4	V		I _{OL} = 16 mA
		3.0		0.22	0.55		0.55			I _{OL} = 24 mA
		4.5		0.22	0.55		0.55			I _{OL} = 32 mA
I _{IN}	Input Leakage Current	0 to 5.5			±1		±10	μΑ	$V_{IN} = 5.5V$, GND
l _{OFF}	Power Off Leakage Current	0.0			1		10	μА	V _{IN} or V _{OL}	_{JT} = 5.5V
I _{CC}	Quiescent Supply Current	1.65 to 5.5			2.0		20	μΑ	$V_{IN} = 5.5V$, GND

AC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C		T _A = -40°	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Conditions	Fig. No.	
		(V)	Min	Тур	Max	Min	Max	Units	Contantions	i ig. ito.
t _{PLH} ,	Propagation Delay	1.65	2.0	5.3	11.5	2.0	12.0			
t _{PHL}		1.8	2.0	4.4	9.5	2.0	10			
		2.5 ± 0.2	0.8	2.9	6.5	0.8	7.0	ns	$C_L = 15 \text{ pF},$ $R_L = 1 \text{ M}\Omega$	Figures 1, 3
		3.3 ± 0.3	0.5	2.3	4.5	0.5	4.7		$R_L = 1 M\Omega$., 0
		5.0 ± 0.5	0.5	1.9	3.9	0.5	4.1			
t _{PLH,}	Propagation Delay	3.3 ± 0.3	1.5	2.9	5.0	1.5	5.2	ns	C _L = 50 pF,	Figures
t _{PHL}		5.0 ± 0.5	0.8	2.4	4.3	8.0	4.5	115	$R_L = 500\Omega$	1, 3
C _{IN}	Input Capacitance	0		4				pF		
C _{PD}	Power Dissipation	3.3		23				pF	(Note 3)	Figure 2
	Capacitance	5.0		30				þΕ	(Note 3)	rigure 2

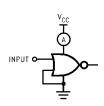
Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC}static)$.

AC Loading and Waveforms



 $\mathbf{C}_{\mathbf{L}}$ includes load and stray capacitance

Input PRR = 1.0 MHz; $t_{\rm w}$ = 500 ns $\label{eq:figure 1.AC Test Circuit}$



Input = AC Waveform; $t_r = t_f = 1.8 \text{ ns};$

PRR = 10 MHz; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

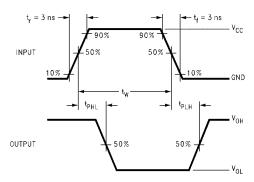


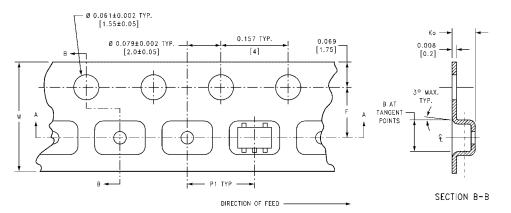
FIGURE 3. AC Waveforms

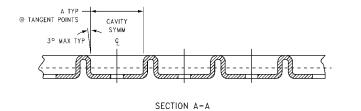
Tape and Reel Specification

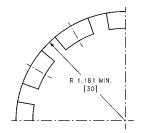
TAPE FORMAT for SC70 and SOT23

Package	Tape	Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
M5X, P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)



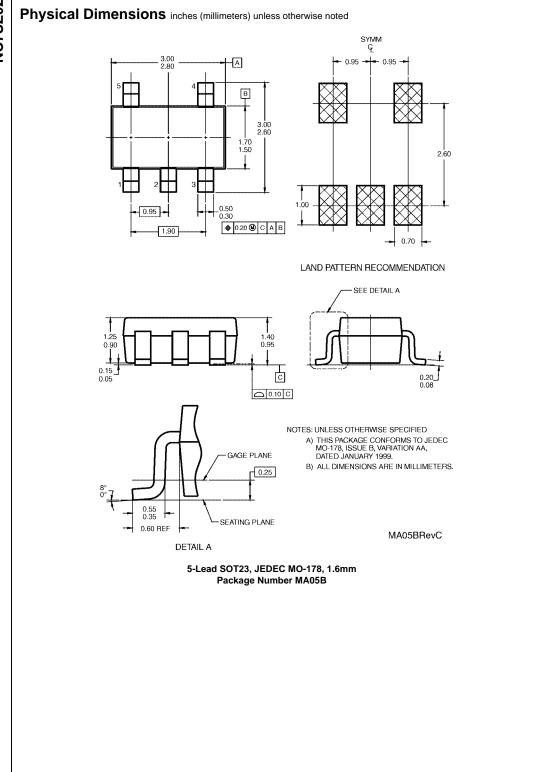




BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ± 0.002	0.055 ± 0.004	0.157	0.315 ± 0.012
		(3.3)	(3.3)	(3.5 ± 0.05)	(1.4 ± 0.11)	(4)	(8 ± 0.3)

Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 ^{+0.30} -0.10 3.50±0.05 1.15±0.05 В ∟ø 0.50 ±0.05 SECTION B-B SCALE:10X 0.254±0.020 ┌ 0.70±0.05 SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X **DETAIL X** SCALE: 3X Tape Α В С D N W1 W2 W3 Size 0.795 2.165 0.331 + 0.059/-0.000 0.567 W1 + 0.078/-0.039 0.059 0.512 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 + 1.50 / -0.00)(14.40)(W1 + 2.00/-1.00)



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 2.00±0.20 0.65 1.9 B- 1.25±0.10 2.10±0.10 0.4 min -0.20 ^{+0.10} -0.05 0.25 LAND PATTERN RECOMMENDATION ♦ max 0.1 **⊗** SEE DETAIL A 0.9±.10 0.95±0.15 max 0.1 R0.14 GAGE PLANE R0.10 0.20 0.45 0.10 - 0.425 NOMINAL DETAIL A

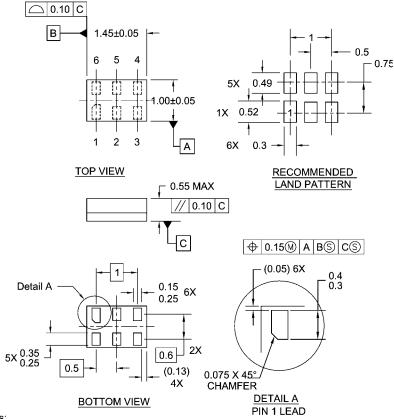
NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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